

## **VERSION WITH MARKINGS TO SHOW CHANGES MADE**

### **In the Specification:**

Paragraph starting at line 4 of page 1 has been amended as follows:

This invention relates to a ~~method of polishing pad for~~ polishing optical fiber connectors ~~and a device which is used in such a method~~. More particularly, this invention relates to a polishing pad to be used in a method as a part of a production process for connectors each with a plurality of optical fibers protruding from a front surface of a main body ~~and a pad which is used in such a polishing process~~ such that the variations in the length of protrusion can be reduced and the protruding optical fibers will each have a flatter front surface.

Paragraph starting at line 22 of page 1 has been amended as follows:

It is therefore an object of this invention to provide a ~~new method of~~ polishing pad for polishing optical fiber connectors with a plurality of optical fibers therethrough such that the optical fibers protrude from the front surface of a main body by an improved length of 1-3 microns and preferably longer with reduced variations and have flatter, smoother and more even front surfaces than was possible ~~with prior art methods~~ by using a prior art polishing pad.